

FMC Module with 2x 250 MSPS 16-bit A/D, 2x 1200 MSPS 16-bit DAC with PLL and Timing Controls

### **FEATURES**

- Two A/D Inputs
  - 250 MSPS, 16-bit option
  - AC or DC coupled
- Two D/A Outputs
  - 1200 MSPS, 16-bit D/A
  - AC or DC coupled
- · Sample clocks and timing and controls
  - External clock/reference input
    - Programmable PLL
    - 10 MHz, 0.5 ppm reference
    - Integrated with FMC triggers
- FMC module, VITA 57.1
  - High Pin Count no SERDES required
  - Compatible with 1.2 to 3.3V VADJ
  - Power monitor and controls
- 6W typical (AC-coupled inputs)
- Conduction Cooling per VITA 20 subset
- Environmental ratings for -40 to 85C 9g RMS sine, 0.1g2/Hz random vibration

### **APPLICATIONS**

- Wireless Receiver and Transmitter
- LTE, WiMAX Physical Layer
- RADAR
- Medical Imaging
- High Speed Data Recording and Playback

### SOFTWARE

MATLAB/VHDL FrameWork Logic





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#### DESCRIPTION

The FMC-250 is a high speed digitizing and signal generation FMC IO module featuring two 250SPS A/D channels and two 1200 MSPS D/A channels supported by sample clock and triggering features.

The FMC-250 features two 16-bit 250 MSPS A/Ds, plus a dual channel, 1200 MSPS update rate DAC. Analog IO may be either AC or DC coupled. Receiver IF frequencies of up to 125 MHz are supported. The sample clock is from either an ultra-low-jitter PLL or external input. Multiple cards can be synchronized for sampling.

The FMC-250 power consumption is 9W for typical operation. The module may be conduction cooled using VITA20 standard and a heat spreading plate. Ruggedization levels for wide-temperature operation from -40 to +85C operation and 0.1 g<sup>2</sup>/Hz vibration. Conformal coating is available.

Support logic in VHDL is provided for integration with FPGA carrier cards. Specific support for Innovative carrier cards includes integration with Framework Logic tools that support VHDL/Verilog and Matlab developers. The Matlab BSP supports real-time hardware-in-the-loop development using the graphical block diagram Simulink environment with Xilinx System Generator for the FMC integrated with the FPGA carrier card.

Software tools for Innovative carrier cards include host development include C++ libraries and drivers for Windows and Linux. Application examples demonstrating the module features are provided.

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This electronics assembly can be damaged by ESD. Innovative Integration recommends that all electronic assemblies and components circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

Product	Part No.	Description	
FMC-250	80315-0- <er></er>	FMC module with two 250 MSPS 16-bit A/Ds, two 1200 MSPS DACs, PLL and timing controls, DC-coupled A/D and DACs	
FMC-250	80315-2- <er></er>	Like 80315-0 except ADC and DAC are AC-coupled	
Cables			
SSMC to BNC cable	67156	IO cable with SSMC (male) to BNC (male), 1 meter	
Carrier Cards			
PEX6-COP	80284	Desktop/server PCI Express FPGA co-processor card with FMC site	
Embedded Computer	Hosts		
<u>ePC-K7</u>	90502	ePC-K7, 17 CPU, K325T2 Commercial FPGA. Embedded PC with support for two FMC modules; COM Express Type 6 CPU; Windows/Linux drivers	
Mini-K7	90600	Mini-K7, Atom CPU, K325T2 Commercial FPGA. Embedded PC with support for one FMC module; COM Express Type 6 CPU; Windows/Linux drivers	

#### **ORDERING INFORMATION**



### FMC-250 Block Diagram





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### **Operating Environment Ratings**

Modules rated for operating environment temperature, shock and vibration are offered. The modules are qualified for wide temperature, vibration and shock to suit a variety of applications in each of the environmental ratings L0 through L4 and 100% tested for compliance.

Environmo <er></er>	ent Rating	LO	L1	L2	L3	L4
Environmer	nt	Office, controlled lab	Outdoor, stationary	Industrial	Vehicles	Military and heavy industry
Application	IS	Lab instruments, research	Outdoor monitoring and controls	Industrial applications with moderate vibration	Manned vehicles	Unmanned vehicles, missiles, oil and gas exploration
Cooling		Forced Air 2 CFM	Forced Air 2 CFM	Conduction	Conduction	Conduction
Operating 7	Temperature	0 to +50C	-40 to +85C	-20 to +65C	-40 to +70C	-40 to +85C
Storage Ter	nperature	-20 to +90C	-40 to +100C	-40 to +100C	-40 to +100C	-50 to +100C
Vibration	Sine	-	-	2g 20-500 Hz	5g 20-2000 Hz	10g 20-2000 Hz
	Random	-	-	0.04 g²/Hz 20-2000 Hz	0.1 g <sup>2</sup> /Hz 20-2000 Hz	0.1 g <sup>2</sup> /Hz 20-2000 Hz
Shock		-	-	20g, 11 ms	30g, 11 ms	40g, 11 ms
Humidity		0 to 95%, non-condensing	0 to 100%	0 to 100%	0 to 100%	0 to 100%
Conformal	coating		Conformal coating	Conformal coating, extended temperature range devices	Conformal coating, extended temperature range devices, Thermal conduction assembly	Conformal coating, extended temperature range devices, Thermal conduction assembly, Epoxy bonding for devices
Testing		Functional, Temperature cycling	Functional, Temperature cycling, Wide temperature testing	Functional, Temperature cycling, Wide temperature testing Vibration, Shock	Functional, Temperature cycling, Wide temperature testing Vibration, Shock	Functional, Testing per MIL- STD-810G for vibration, shock, temperature, humidity

Minimum lot sizes and NRE charges may apply. Contact sales support for pricing and availability.

### **Standard Features**

Analog Input	
Inputs	2
Input Range	+/-1V
Input Type	Single ended, AC or DC coupled
Input Impedance	50 ohm
A/D Device	Intersil ISL216P25 (250MSPS, 16-bit)
A/D Resolution	16-bit
A/D Sample Rate	10 MHz to 250 MHz
Input Bandwidth	300 MHz (-3dB) (AC-Coupled) 250 MHz (-3dB) (DC-Coupled)

<b>Clocks and Triggering</b>	
Clock Sources	LMK0480xB PLL or External
	0.3125 to 500 MHz
PLL Reference	External or 10MHz on-card 10MH ref is +/-250ppb -40to +85C
PLL Resolution	80 kHz Tuning Resolution
Phase Noise	-130 dBc @ 100 kHz
Triggering	External, software, acquire N frame
Decimation	1:1 to 1:4095 in FPGA
Channel Clocking	All channels are synchronous
Multi-card Synchronization	External triggering input is used to synchronize sample clocks or an external clock and trigger may be used.

	FMC Interface	FMC Interface		
oled	IO	LA[33:0] pairs, HA[22:0] pairs, HB[12:0] pairs		
Z	IO Standards	LA: LVDS HA: LVDS HB : LVCMOS 1.2V to 3.3V		
	Required voltages	3.3V, 3.3V AUX VADJ = 1.2V to 3.3V		

Reliability	
MTBF 2	293,106 Hours

Analog Output	
Outputs	2
Output Range	+/-1.0V AC or DC-coupled
Output Type	Single ended, AC or DC coupled
Output Impedance	50 ohm
DAC Device	Analog Devices AD9122BCPZ
DAC Resolution	16-bit
DAC Update Rate	10 MHz to 1200 MHz
Interpolation	None, 2x, 4x
Output Bandwidth	600 MHz (-3dB) AC or DC-Coupled

Power	
Consumption	6W total 3.3V @ 1.7A 3.3V AUX @ 0.05A VADJ @ 0.1A
Heat Sinking	Conduction cooling supported (VITA20 subset)
Physicals	
Form Factor	FMC VITA 57.1 single-width
Size	76.5 x 69 mm 10 mm mounting height
Weight	100g
Hazardous Materials	Lead-free and RoHS compliant

ELECTRICAL CHARACTERISTICS Over recommended operating free-air temperature range at 0°C to +60°C, unless otherwise noted.				
Parameter	Тур	Units	Notes	
A/D Channels				
Analog Input Bandwidth	250	MHz	-3dB, DC coupled inputs	
	300	MHz	-3dB, AC coupled inputs	
Analog Input Passband Flatness	0.5	dB	0 to 125 MHz, DC Coupled	
	0.4	dB	0 to 125 MHz, AC Coupled	
Broadband SFDR	82.2	dB	Fin = 5.1 MHz, 95% FS, sine sampled at 250 MSPS; Broadband DC to 125 MHz, AC Coupled	
	80.2	dB	Fin = 70.1 MHz, 95% FS, sine sampled at 250 MSPS; Broadband DC to 125 MHz, AC Coupled	
SFDR, 70 MHz carrier +/-5 MHz band	91	dB	Fin = 70 MHz, 95% FS, sine sampled at 250 MSPS; Broadband DC to 200 MHz, DC Coupled	
Harmonic Distortion	-79	dB	Fin = 70 MHz, 95% FS, sine sampled at 250 MSPS;	
	-67	dB	Fin = 125 MHz, 95% FS, sine sampled at 250 MSPS;	
ENOB	11.8	bits	Fin = 5.1 MHz, 95% FS, sine sampled at 250 MSPS; Broadband DC to 125 MHz, AC Coupled	
	11.5	bits	Fin = 70 MHz, 95% FS, sine sampled at 250 MSPS; Broadband DC to 125 MHz, AC Coupled	
SNR	73.3	dB	Fin = 5.1 MHz, 95% FS, sine sampled at 250 MSPS; AC Coupled	
	71.7	dB	Fin = 70 MHz, 95% FS, sine sampled at 250 MSPS; AC Coupled	
Crosstalk	< -90	dB	Measured channel grounded with a 70.5 MHz, 95% FS sine input on other channel	
Noise Floor	-120	dB	Fin = 70.1 MHz, -4dBFS, sine sampled at 250 MSPS, AC coupled	
Offset Error	700	μV	Factory calibration, average of 64K samples after warmup.	
Gain Error	<0.5	%	Factory calibration after warmup.	

ELECTRICAL CHARACTE	RISTICS		
Over recommended operating free-air ter	mperature range at 0°C	C to $+60^{\circ}$ C, un	less otherwise noted.
Parameter	Тур	Units	Notes
DAC Channels			
Analog Output Range	+/-1000	mV	Typical, AC Coupled
	+/-1000	mV	Typical, DC Coupled
Analog Output Bandwidth	600	MHz	DC Coupled, no sinc compensation
	600	MHz	AC Coupled, no sinc compensation
Output Amplitude Variation	0.7	dB	0-100 MHz, DC Coupled, no sinc compensation
	0.8	dB	1-100 MHz, AC Coupled, no sinc compensation
SFDR	68	dB	20 MHz sine output, 1.2 dBm, DC coupled
	70	dB	20 MHz sine output, 1.2 dBm, AC coupled
S/N	59.7	dB	70.1 MHz sine output, -6 dBfs, AC coupled
	58	dB	70.1 MHz sine output, -6 dBfs, DC coupled
THD	-62	dB	70.1 MHz sine output, -6 dBfs, AC coupled
	-49	dB	70.1 MHz sine output, -6 dBfs, DC coupled
Intermodulation Distortion	<-75	dB	70+/-0.1 MHz, -6dBfs, AC Coupled
Channel Crosstalk	<-85	dB	Aggressor = 125.1 MHz, -3 dBfs adjacent channel
Noise floor	-100	dB	AC or DC output
Gain Error	<0.5	% of FS	Calibrated
Offset Error	<10	mV	Calibrated



DC-Coupled A/D ENOB vs Frequency. Fs = 250 MHz onboard PLL.	DC-Coupled A/D SNR vs Frequency. Fs = 250 MHz onboard PLL.
DC-Coupled A/D SFDR vs Frequency. Fs = 250 MHz onboard PLL.	DC-Coupled A/D THD vs Frequency. Fs = $250 \text{ MHz}$ onboard PLL
DC-Coupled A/D Frequency Response. Fs = 250 MHz onboard PLL.	

### **ADC Performance**













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